

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT
NATURE OF CONVEYANCE:		ASSIGNMENT
CONVEYING PARTY DATA		
Name		Execution Date
S. Brad Herner		11/14/2006
RECEIVING PARTY DATA		
Name:	SanDisk Corporation	
Street Address:	601 McCarthy Boulevard	
City:	Milpitas	
State/Country:	CALIFORNIA	
Postal Code:	95035	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11560283	
CORRESPONDENCE DATA		
Fax Number:	(415)369-9665	
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
Phone:	4153699660	
Email:	trau@vierramagen.com	
Correspondent Name:	Pamela J. Squyres	
Address Line 1:	575 Market Street, Suite 2500	
Address Line 4:	San Francisco, CALIFORNIA 94105-2871	
ATTORNEY DOCKET NUMBER:	SAND-01132US0	
NAME OF SUBMITTER:	Pamela J. Squyres	
Total Attachments: 2		
source=1132-SignedAssignment#page1.tif		
source=1132-SignedAssignment#page2.tif		

CH \$40.00 11560283

SOLE TO CORPORATE ASSIGNMENT

WHEREAS, the undersigned, S. BRAD HERNER, a resident of 1289 Mildred Avenue, San Jose, California 95125 (hereinafter termed "Inventor"), has invented certain new improvements in:

METHOD FOR MAKING A P-I-N DIODE CRYSTALLIZED ADJACENT
TO A SILICIDE IN SERIES WITH A DIELECTRIC ANTIFUSE

and has executed a declaration for an application for a United States patent disclosing and identifying the invention, the declaration being executed on November 14, 2006.

WHEREAS SanDisk Corporation (hereinafter termed "Assignee"), a corporation of the State of Delaware, having a place of business at 601 McCarthy Boulevard, Milpitas, State of California, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any and all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths,

specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, said Inventor's heirs, legal representatives and assigns.

4. Said Inventor hereby warrants and represents that said Inventor has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

Dated: November 14, 2006 Scott Brad Herner
S. BRAD HERNER